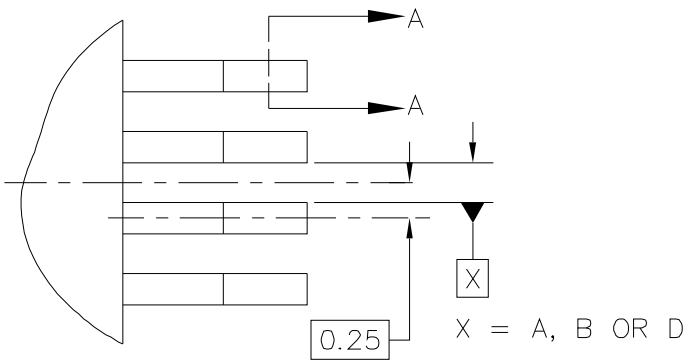
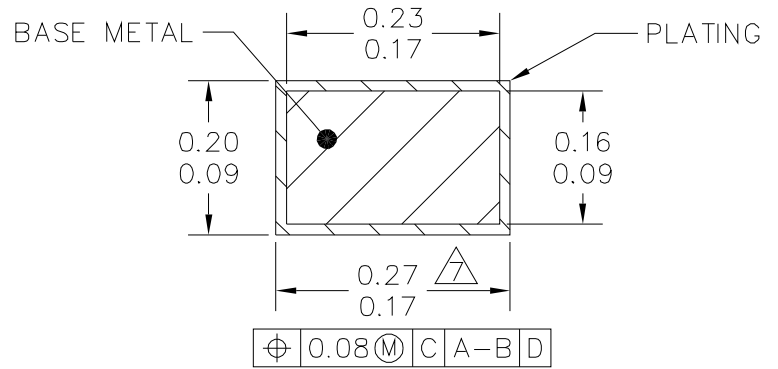


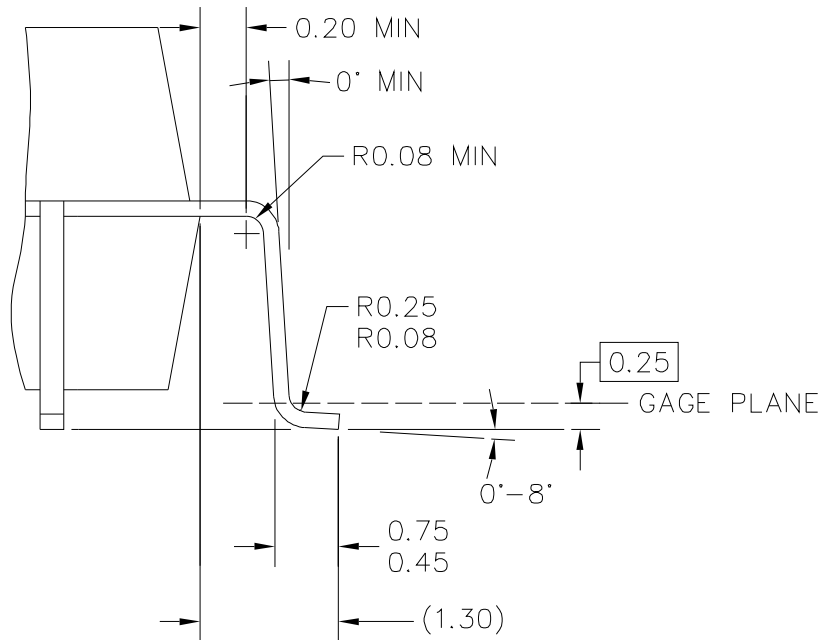
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VIEW A
3 PLACES



SECTION A-A
160 PLACES
ROTATED 90° CW



VIEW B

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	STANDARD: NON-JEDEC	
	SOT1696-1	29 JAN 2016



NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M-1994.

2. DIMENSIONS IN MILLIMETERS.

3. DATUM PLANE IS COINCIDENT WITH THE BOTTOM OF THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.

4. DATUMS TO BE DETERMINED AT DATUM PLANE H.

5. DIMENSIONS TO BE DETERMINED AT SEATING PLANE DATUM C.

6. DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 PER SIDE. DIMENSIONS INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.

7. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.35.

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